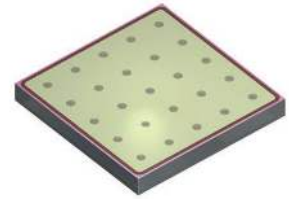


# GD VJLPE1.14

## OSLON® Pure 1010

Industry most compact high power chip-scale package LED with high performance, superior robustness and long lifetime.



### Applications

- Architecture / Garden Lighting (LED & Laser)
- Downlights/Spotlights
- Medical Illumination
- Photo Therapy

### Features:

- Package: chip level conversion
- Typ. Radiation: 120° (Lambertian emitter)
- Radiant Flux: typ. 1140 mW
- Radiant Efficiency: typ. 55 %

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## Ordering Information

Type	Total radiant flux <sup>1)</sup> $I_F = 700 \text{ mA}$ $\Phi_E$	Ordering Code
GD VJLPE1.14-T1T4-AD-1	1020.0 ... 1185.0 mW	Q65113A0463

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## Maximum Ratings

Parameter	Symbol		Values
Operating Temperature	$T_{op}$	min.	-40 °C
		max.	85 °C
Storage Temperature	$T_{stg}$	min.	-40 °C
		max.	85 °C
Junction Temperature	$T_j$	max.	125 °C
Forward current	$I_F$	min.	30 mA
		max.	1000 mA
Reverse voltage <sup>2)</sup>	$V_R$		Not designed for reverse operation
ESD withstand voltage acc. ANSI/ESDA/JEDEC JS-001 (HBM, Class 0)	$V_{ESD}$		ESD sensitive device

## Characteristics

$I_F = 700 \text{ mA}$ ;  $T_J = 25 \text{ °C}$

Parameter	Symbol		Values
Dominant Wavelength <sup>3)</sup> $I_F = 700 \text{ mA}$	$\lambda_{\text{dom}}$	min.	445 nm
		typ.	453 nm
		max.	455 nm
Viewing angle at 50% $I_V$	$2\varphi$	typ.	120 °
Forward Voltage <sup>4)</sup> $I_F = 700 \text{ mA}$	$V_F$	min.	2.70 V
		typ.	2.95 V
		max.	3.20 V
Reverse current <sup>2)</sup>	$I_R$		Not designed for reverse operation
Electrical thermal resistance junction/solderpoint with efficiency $\eta_e = 51 \%$	$R_{\text{thJS elec.}}$	typ.	6.3 K / W

## Brightness Groups

Group	Total radiant flux <sup>1)</sup> $I_F = 700 \text{ mA}$ min. $\Phi_E$	Total radiant flux <sup>1)</sup> $I_F = 700 \text{ mA}$ max. $\Phi_E$
T1	1020.0 mW	1060.0 mW
T2	1060.0 mW	1100.0 mW
T3	1100.0 mW	1140.0 mW
T4	1140.0 mW	1185.0 mW

## Forward Voltage Groups

Group	Forward Voltage <sup>4)</sup> $I_F = 700 \text{ mA}$ min. $V_F$	Forward Voltage <sup>4)</sup> $I_F = 700 \text{ mA}$ max. $V_F$
1V	2.70 V	2.75 V
1W	2.75 V	2.80 V
1Y	2.80 V	2.85 V
1Z	2.85 V	2.90 V
2A	2.90 V	2.95 V
2B	2.95 V	3.00 V
2C	3.00 V	3.05 V
2D	3.05 V	3.10 V
2E	3.10 V	3.15 V
2F	3.15 V	3.20 V

## Wavelength Groups

Group	Dominant Wavelength <sup>3)</sup> $I_F = 700 \text{ mA}$ min. $\lambda_{\text{dom}}$	Dominant Wavelength <sup>3)</sup> $I_F = 700 \text{ mA}$ max. $\lambda_{\text{dom}}$
A	445 nm	448 nm
B	448 nm	450 nm
C	450 nm	453 nm
D	453 nm	455 nm

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## Group Name on Label

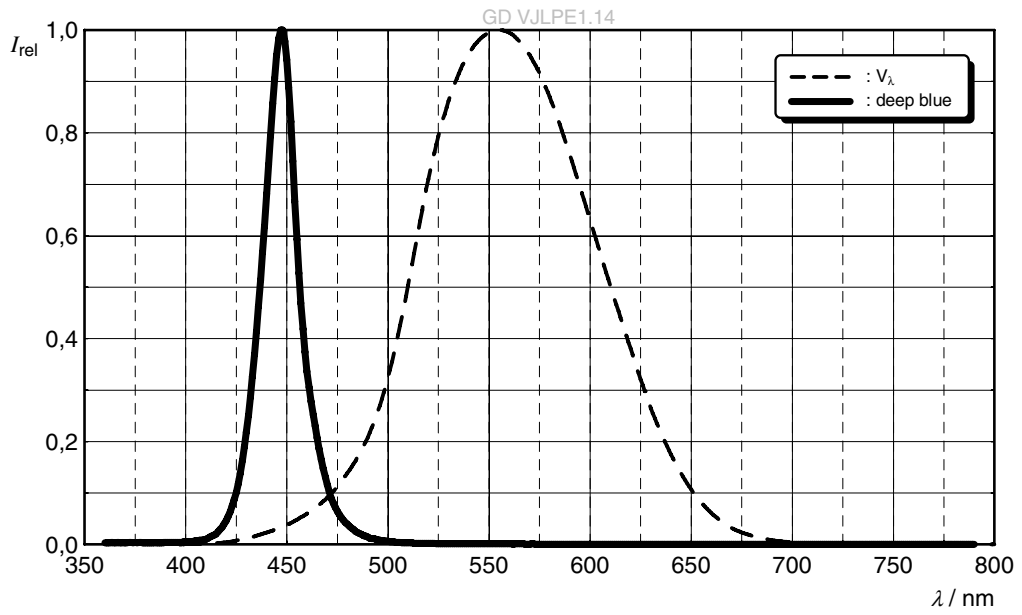
**Example: T1-A-1V**

Brightness	Wavelength	Forward Voltage
T1	A	1V

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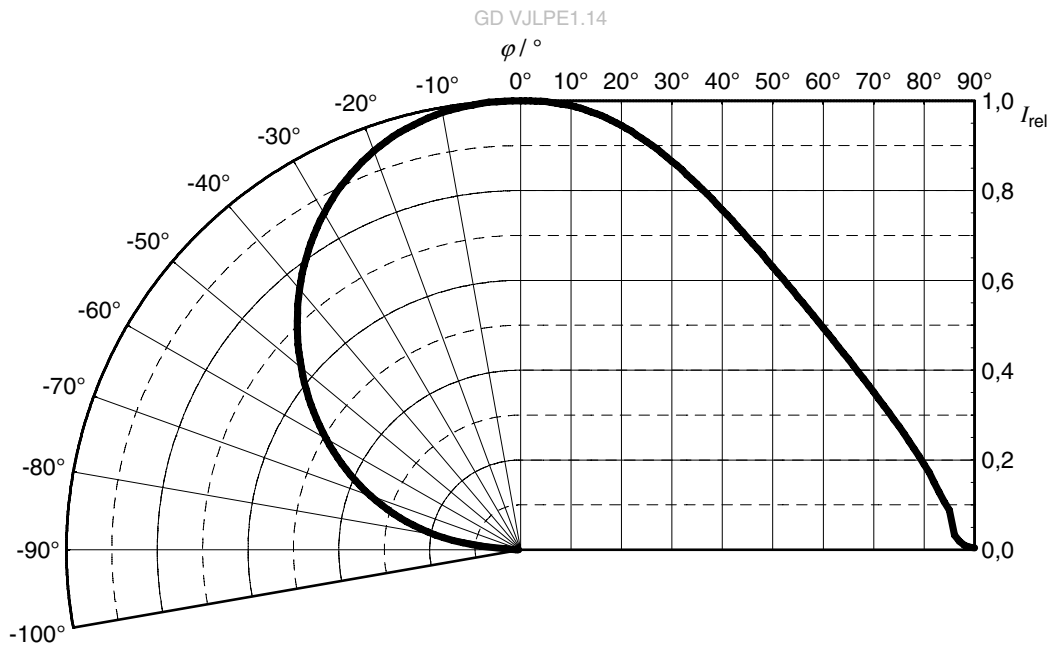
**Relative Spectral Emission** <sup>5)</sup>

$I_{rel} = f(\lambda)$ ;  $I_F = 700 \text{ mA}$ ;  $T_J = 25 \text{ }^\circ\text{C}$



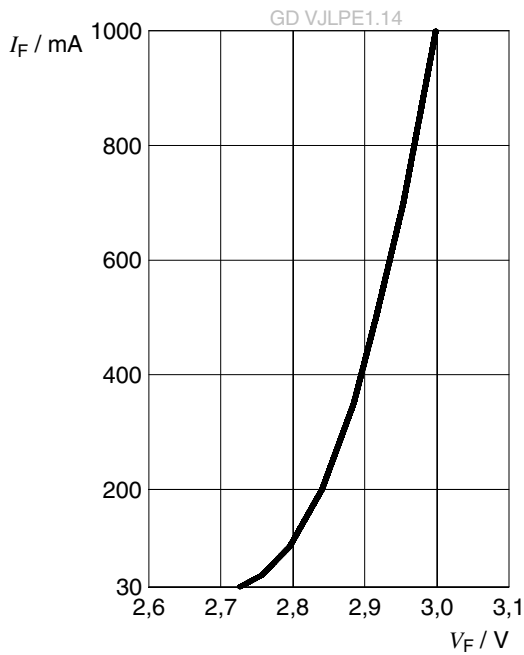
**Radiation Characteristics** <sup>5)</sup>

$I_{rel} = f(\phi)$ ;  $T_J = 25 \text{ }^\circ\text{C}$



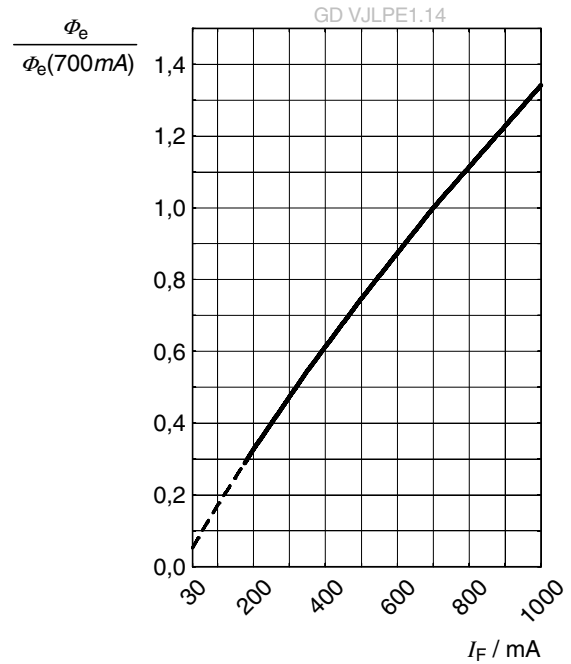
**Forward current** <sup>5)</sup>

$I_F = f(V_F); T_J = 25\text{ }^\circ\text{C}$



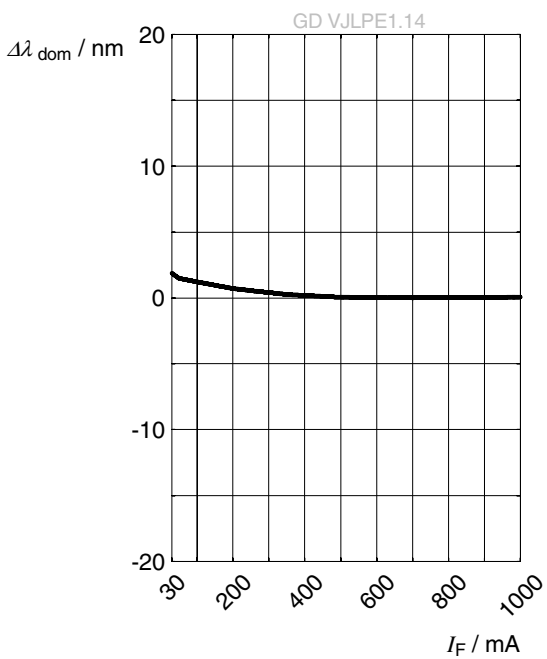
**Relative Radiant Power** <sup>5), 6)</sup>

$\Phi_E / \Phi_E(700\text{ mA}) = f(I_F); T_J = 25\text{ }^\circ\text{C}$



**Dominant Wavelength** <sup>5)</sup>

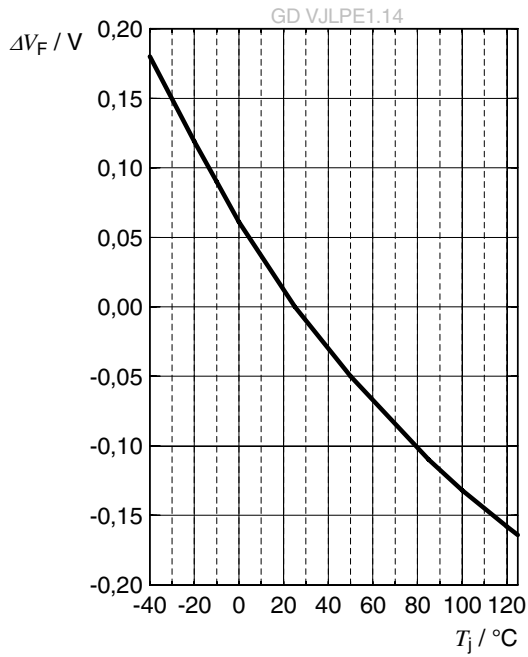
$\Delta\lambda_{\text{dom}} = f(I_F); T_J = 25\text{ }^\circ\text{C}$





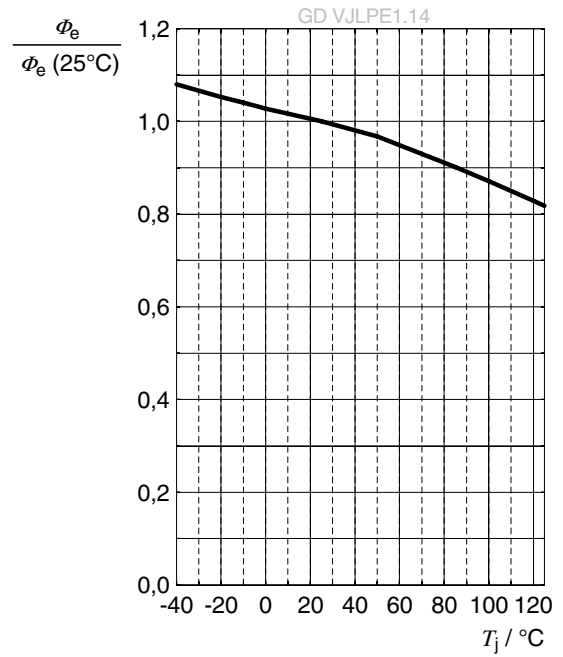
**Forward Voltage** <sup>5)</sup>

$$\Delta V_F = V_F - V_F(25\text{ °C}) = f(T_j); I_F = 700\text{ mA}$$



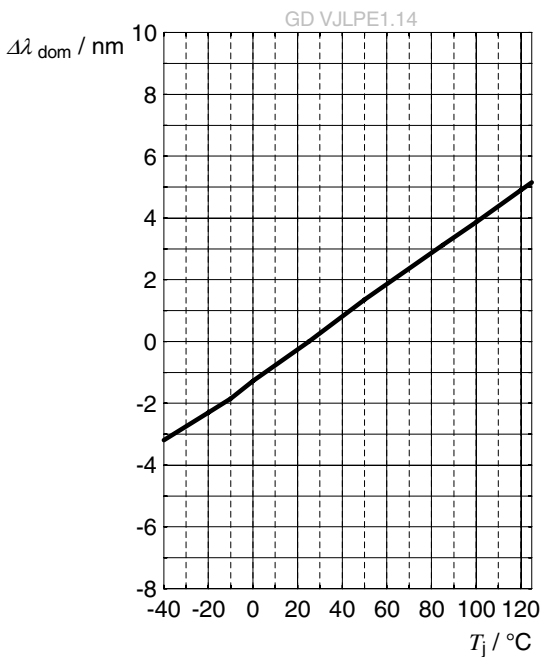
**Relative Radiant Power** <sup>5)</sup>

$$\Phi_E / \Phi_E(25\text{ °C}) = f(T_j); I_F = 700\text{ mA}$$



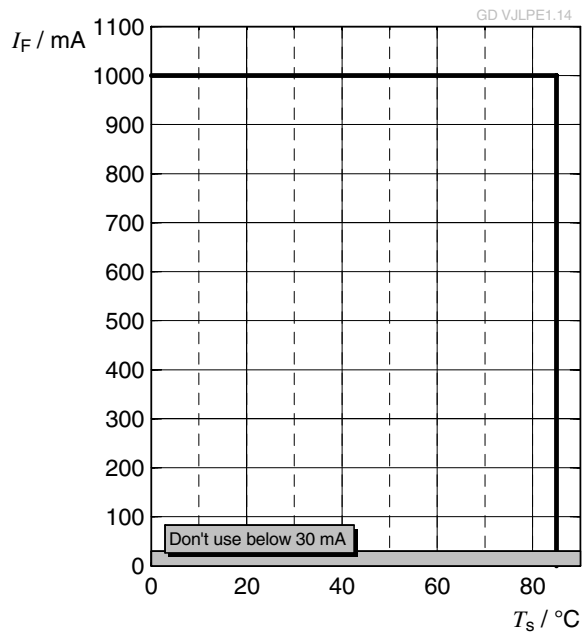
**Dominant Wavelength** <sup>5)</sup>

$$\Delta \lambda_{\text{dom}} = \lambda_{\text{dom}} - \lambda_{\text{dom}}(25\text{ °C}) = f(T_j); I_F = 700\text{ mA}$$

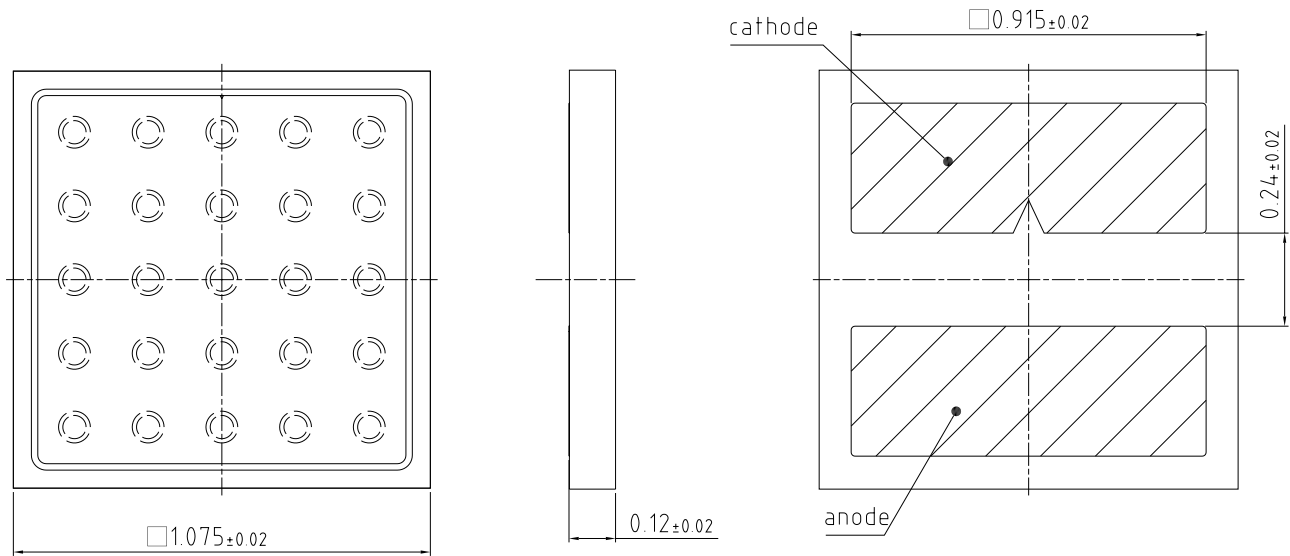



## Max. Permissible Forward Current

$$I_F = f(T)$$



## Dimensional Drawing <sup>7)</sup>



general tolerance  $\pm 0.05$   
 lead finish Au 

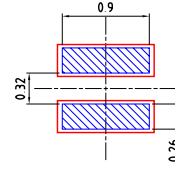
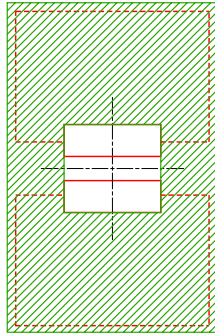
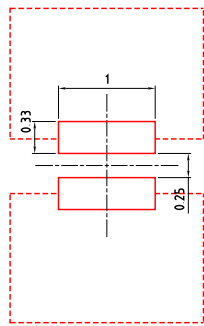
C67062-A0269-A1-01

### Further Information:

**Approximate Weight:** 0.8 mg

**Package marking:** Cathode

## Recommended Solder Pad <sup>7)</sup>

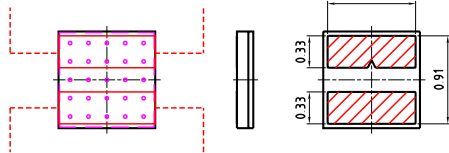


□ foot print □ Cu area

▨ solder resist

▨ solder stencil  
recommended stencil  
thickness 80µm

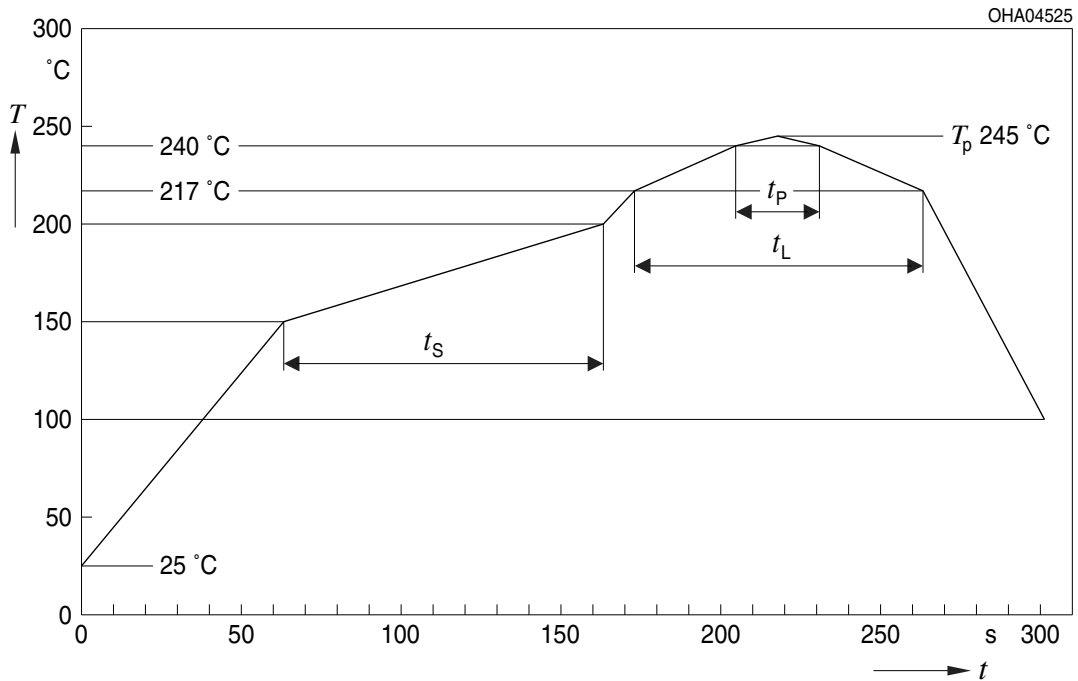
Component Location on Pad



E062 3010 221 - 01

## Reflow Soldering Profile

Product complies to MSL Level 2 acc. to JEDEC J-STD-020E

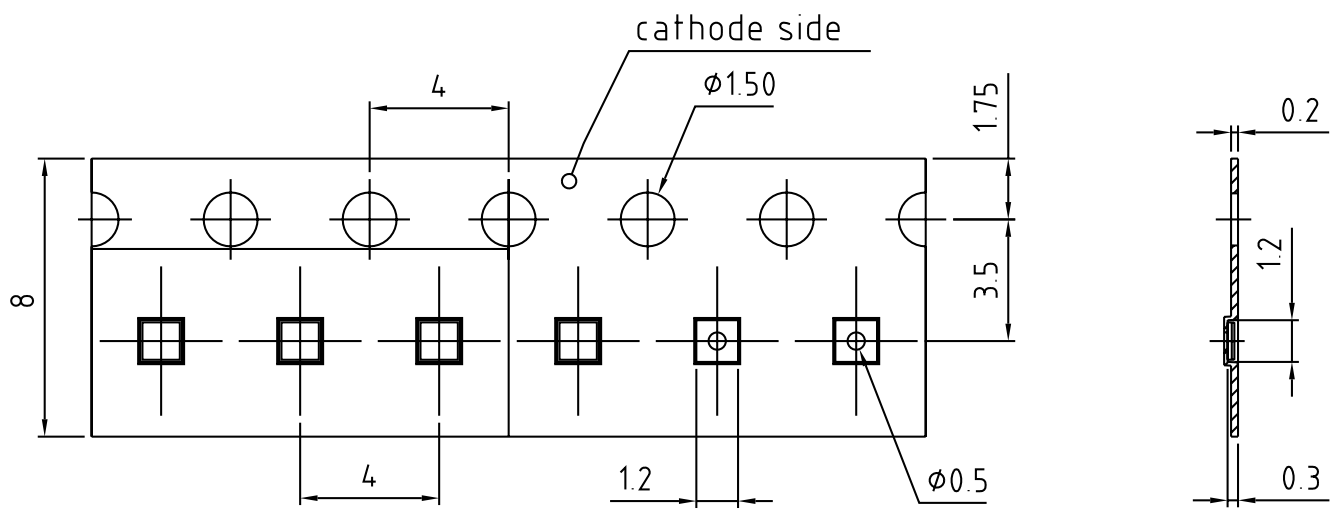


Profile Feature	Symbol	Pb-Free (SnAgCu) Assembly			Unit
		Minimum	Recommendation	Maximum	
Ramp-up rate to preheat <sup>*)</sup> 25 °C to 150 °C			2	3	K/s
Time $t_s$ $T_{Smin}$ to $T_{Smax}$	$t_s$	60	100	120	s
Ramp-up rate to peak <sup>*)</sup> $T_{Smax}$ to $T_p$			2	3	K/s
Liquidus temperature	$T_L$		217		°C
Time above liquidus temperature	$t_L$		80	100	s
Peak temperature	$T_p$		245	260	°C
Time within 5 °C of the specified peak temperature $T_p - 5$ K	$t_p$	10	20	30	s
Ramp-down rate* $T_p$ to 100 °C			3	6	K/s
Time 25 °C to $T_p$				480	s

All temperatures refer to the center of the package, measured on the top of the component

\* slope calculation  $DT/Dt$ :  $Dt$  max. 5 s; fulfillment for the whole T-range

Taping <sup>7)</sup>



C67062-A0296-B6 -04

**Tape and Reel** <sup>8)</sup>



**Reel Dimensions**

A	W	N <sub>min</sub>	W <sub>1</sub>	W <sub>2max</sub>	Pieces per PU
180 mm	12 + 0.3 / - 0.1 mm	60 mm	12.4 + 2 mm	18.4 mm	600

### Barcode-Product-Label (BPL)

**OSRAM Opto Semiconductors** LX XXXX BIN1: XX-XX-X-XXX-X

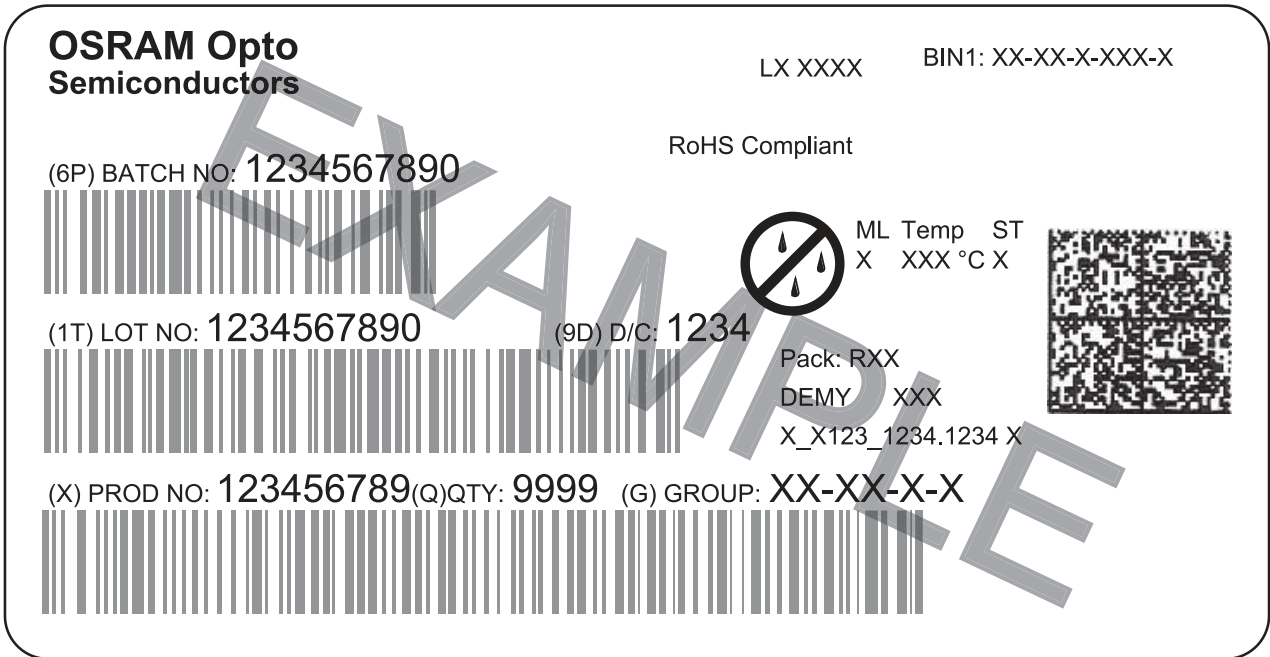
RoHS Compliant

(6P) BATCH NO: 1234567890 ML Temp ST  
X XXX °C X

(1T) LOT NO: 1234567890 (9D) D/C: 1234

Pack: RXX  
DEMY XXX  
X\_X123\_1234.1234 X

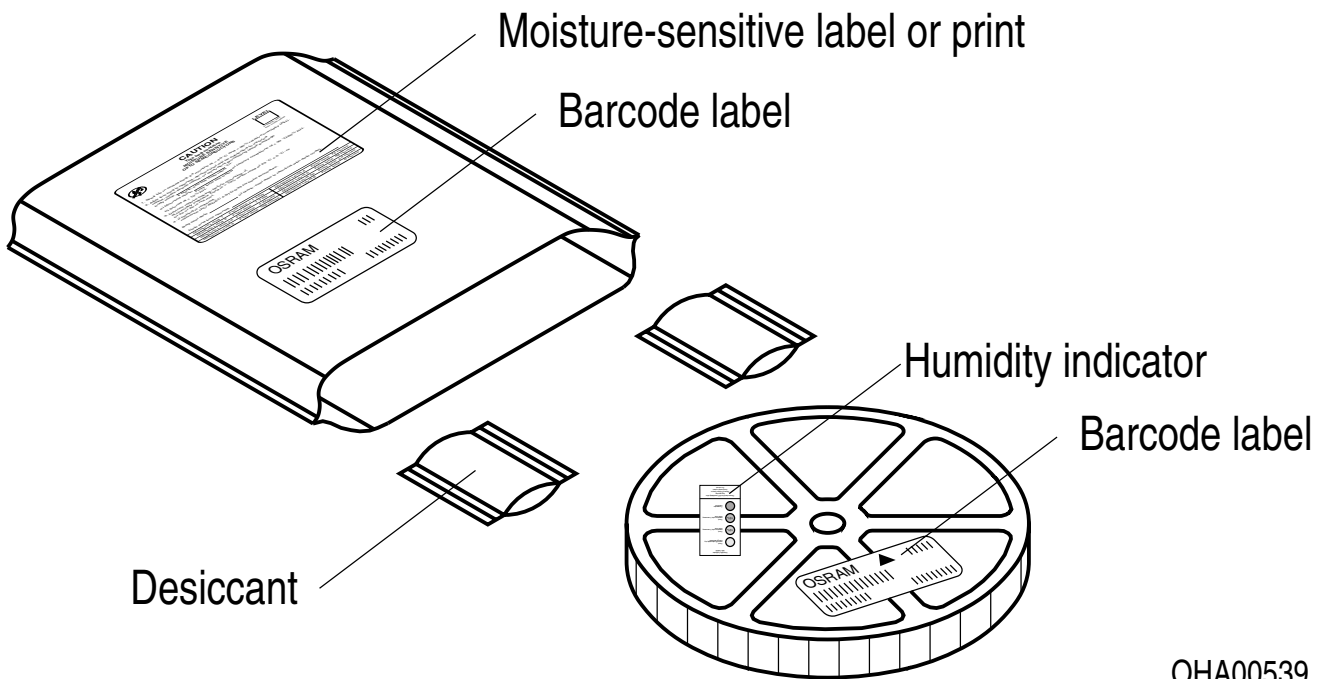
(X) PROD NO: 123456789(Q)QTY: 9999 (G) GROUP: XX-XX-X-X



The diagram shows a rectangular label with rounded corners. It contains the OSRAM logo and company name at the top left. To the right are fields for 'LX XXXX' and 'BIN1: XX-XX-X-XXX-X'. Below the logo is a 'RoHS Compliant' statement. The label features three horizontal barcode sections. The first is labeled '(6P) BATCH NO: 1234567890' and is accompanied by a 'no liquid' symbol and 'ML Temp ST X XXX °C X'. The second is labeled '(1T) LOT NO: 1234567890' and '(9D) D/C: 1234', with 'Pack: RXX', 'DEMY XXX', and 'X\_X123\_1234.1234 X' below it. The third is labeled '(X) PROD NO: 123456789(Q)QTY: 9999 (G) GROUP: XX-XX-X-X'. A square QR code is located on the right side of the label.

OHA04563

### Dry Packing Process and Materials



OHA00539

Moisture-sensitive product is packed in a dry bag containing desiccant and a humidity card according JEDEC-STD-033.



## Notes

The evaluation of eye safety occurs according to the standard IEC 62471:2006 (photo biological safety of lamps and lamp systems). Within the risk grouping system of this IEC standard, the device specified in this data sheet falls into the class **moderate risk (exposure time 0.25 s)**. Under real circumstances (for exposure time, conditions of the eye pupils, observation distance), it is assumed that no endangerment to the eye exists from these devices. As a matter of principle, however, it should be mentioned that intense light sources have a high secondary exposure potential due to their blinding effect. When looking at bright light sources (e.g. headlights), temporary reduction in visual acuity and afterimages can occur, leading to irritation, annoyance, visual impairment, and even accidents, depending on the situation.

Subcomponents of this device contain, in addition to other substances, metal filled materials including silver. Metal filled materials can be affected by environments that contain traces of aggressive substances. Therefore, we recommend that customers minimize device exposure to aggressive substances during storage, production, and use. Devices that showed visible discoloration when tested using the described tests above did show no performance deviations within failure limits during the stated test duration. Respective failure limits are described in the IEC60810.

This device is designed for specific/recommended applications only. Please consult OSRAM Opto Semiconductors Sales Staff in advance for detailed information on other non-recommended applications (e.g. automotive).

Change management for this component is aligned with the requirements of the lighting market.

For further application related information please visit [www.osram-os.com/appnotes](http://www.osram-os.com/appnotes)

## Disclaimer

### **Attention please!**

The information describes the type of component and shall not be considered as assured characteristics. Terms of delivery and rights to change design reserved. Due to technical requirements components may contain dangerous substances.

For information on the types in question please contact our Sales Organization.

If printed or downloaded, please find the latest version on the OSRAM OS website.

### **Packing**

Please use the recycling operators known to you. We can also help you – get in touch with your nearest sales office. By agreement we will take packing material back, if it is sorted. You must bear the costs of transport. For packing material that is returned to us unsorted or which we are not obliged to accept, we shall have to invoice you for any costs incurred.

### **Product and functional safety devices/applications or medical devices/applications**

OSRAM OS components are not developed, constructed or tested for the application as safety relevant component or for the application in medical devices.

OSRAM OS products are not qualified at module and system level for such application.

In case buyer – or customer supplied by buyer – considers using OSRAM OS components in product safety devices/applications or medical devices/applications, buyer and/or customer has to inform the local sales partner of OSRAM OS immediately and OSRAM OS and buyer and /or customer will analyze and coordinate the customer-specific request between OSRAM OS and buyer and/or customer.

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## Glossary

- 1) **Brightness:** Brightness values are measured during a current pulse of typically 10 ms, with a tolerance of +/- 7%.
- 2) **Reverse Operation:** Not designed for reverse operation. Continuous reverse operation can cause migration and damage of the device.
- 3) **Wavelength:** The wavelength is measured at a current pulse of typically 10 ms, with a tolerance of  $\pm 0.5$  nm.
- 4) **Forward Voltage:** The Forward voltage is measured during a current pulse duration of typically 1 ms with a tolerance of  $\pm 0.05V$ .
- 5) **Typical Values:** Due to the special conditions of the manufacturing processes of semiconductor devices, the typical data or calculated correlations of technical parameters can only reflect statistical figures. These do not necessarily correspond to the actual parameters of each single product, which could differ from the typical data and calculated correlations or the typical characteristic line. If requested, e.g. because of technical improvements, these typ. data will be changed without any further notice.
- 6) **Characteristic curve:** In the range where the line of the graph is broken, you must expect higher differences between single devices within one packing unit.
- 7) **Tolerance of Measure:** Unless otherwise noted in drawing, tolerances are specified with  $\pm 0.1$  and dimensions are specified in mm.
- 8) **Tape and Reel:** All dimensions and tolerances are specified acc. IEC 60286-3 and specified in mm.

## Revision History

Version	Date	Change
1.0	2020-03-23	Initial Version
1.0	2020-09-10	Product Image
1.1	2020-11-23	Applications

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**Leibnizstraße 4, D-93055 Regensburg**  
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按照中国的相关法规和标准，不含有毒有害物质或元素。